Product Specification

QNN180N04AX

40V N-Channel MOSFET

FEATURES

- 40V,100A

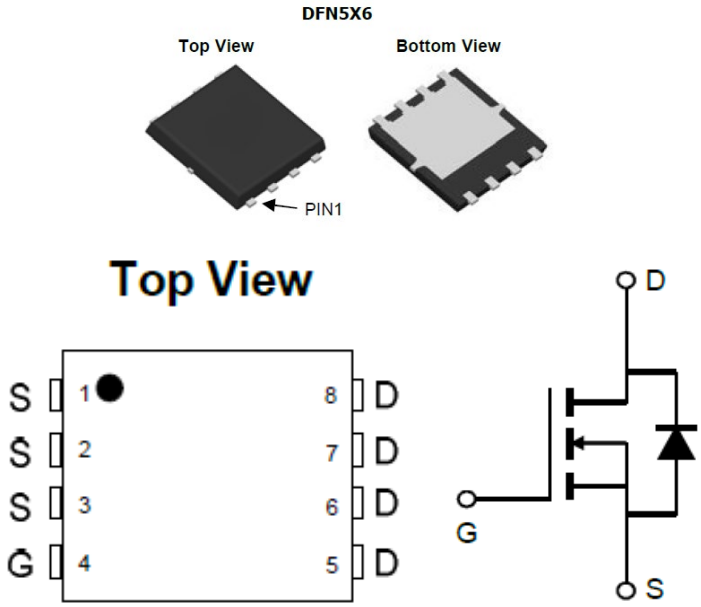
  $R_{DS(ON)}$ =2.2mΩ @ V_{GS} = 10V (Typ.)

  $R_{DS(ON)}$ =3mΩ @ V_{GS} = 4.5V (Typ.)
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- Halogen-free; RoHS-compliant
- Pb-free plating

Applications

- Load Switch
- PWM Application
- Power Management

Pin Description



NO.	Symbol	Description
1	S	SOURCE
2	S	SOURCE
3	S	SOURCE
4	G	GATE
5	D	DRAIN
6	D	DRAIN
7	D	DRAIN
8	D	DRAIN

Absolute Maximum Ratings

(@ T_C = 25℃ unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{DS}	Drain-to-Source Voltage		40	V
V_{GS}	Gate-to-Source Voltage		±20	V
I_D	Continuous Drain Current	T_C=25℃	100	A
		T_C=100℃	65	
I_{DM}	Pulsed Drain Current (1)		400	A
E_{AS}	Single Pulsed Avalanche Energy (2)		225	mJ
P_D	Power Dissipation	T_C= 25℃	61	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case		2.0	℃/W
T_J, T_{STG}	Junction & Storage Temperature Range		-55 to 150	℃

Electrical Characteristics

(T_J = 25℃ unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	I_D=250uA,V_{GS}=0V	120	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=40V,V_{GS}=0V	-	-	1.0	uA
I_{GSS}	Gate-Body Leakage Current	V_{DS}=0V,V_{GS}=±20V	-	-	±100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250uA	1.4	1.5	2.5	V
$R_{DS(ON)}$	Static Drain-Source ON-Resistance(3)	V_{GS}=10V, I_D=20A	-	2.2	2.8	mΩ
		V_{GS}=4.5V,I_D=10A	-	3	3.9	mΩ
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=20V, f=1MHz	-	5595	-	pF
C_{oss}	Output Capacitance		-	411	-	pF
C_{rss}	Reverse Transfer Capacitance		-	340	-	pF
Q_g	Total Gate Charge	V_{GS}=0~10V, V_{DS}=20V, I_D=30A	-	59	-	nC
Q_{gs}	Gate Source Charge		-	12.5	-	nC
Q_{gd}	Gate Drain("Miller") Charge		-	15	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On DelayTime	V_{GS}=10V, V_{DD}=20V I_D=30A ,R_{GEN}=3Ω	-	12	-	ns
t_r	Turn-On Rise Time		-	16	-	ns
$t_{d(off)}$	Turn-Off DelayTime		-	39	-	ns
t_f	Turn-Off Fall Time		-	15	-	ns
Drain-Source Diode Characteristics and Max Ratings						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	100	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	400	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS}=0V, I_S=30 A	-	-	1.2	V
t_{rr}	Body Diode Reverse Recovery Time	I_F=30A, di/dt=100A/us	-	22	-	ns
Q_{rr}	Body Diode Reverse Recovery Charge		-	11	-	nC

Notes:

1.Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2.E_{AS} condition: Starting T_J=25℃, V_{DD}=15V, V_G=10V, R_G=25Ω, L=0.5mH, I_{AS}=30A

3.Pulse Test: Pulse Width≤300us, Duty Cycle≤0.5%.

Typical Performance Characteristics

Figure 1: Output Characteristics

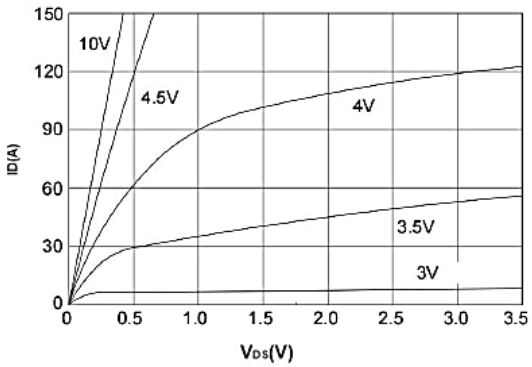


Figure 2: Typical Transfer Characteristic

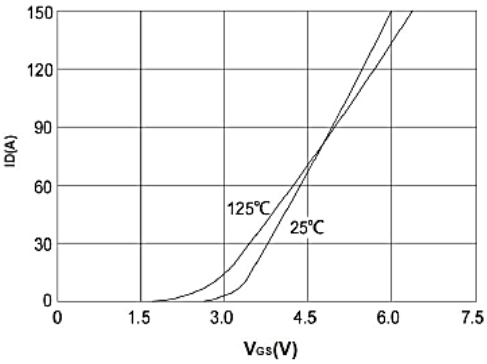


Figure 3: On-resistance vs. Drain Current

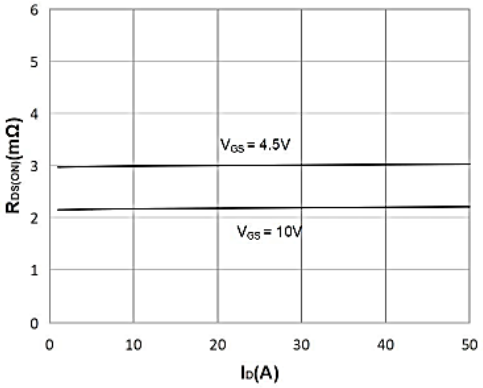


Figure 4: Body Diode Characteristics

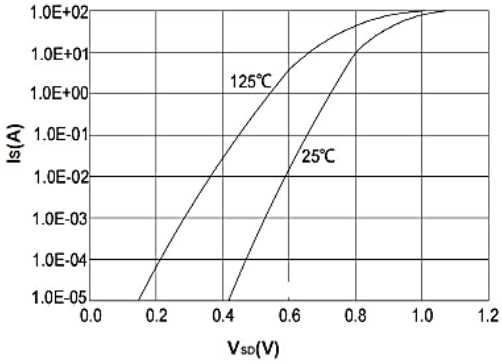


Figure 5: Gate Charge Characteristics

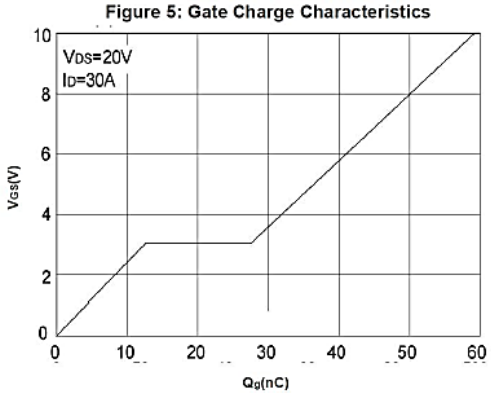


Figure 6: Capacitance Characteristics

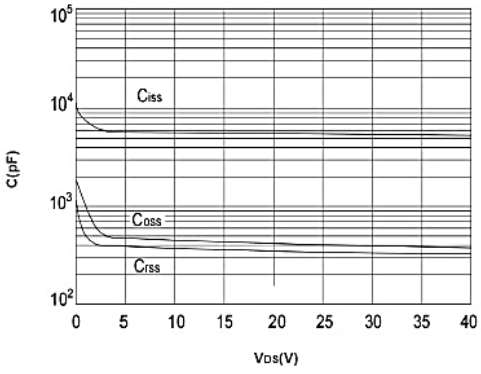


Figure 7: Normalized Breakdown voltage vs. Junction Temperature

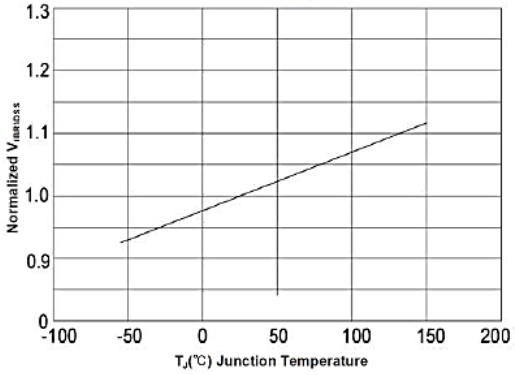
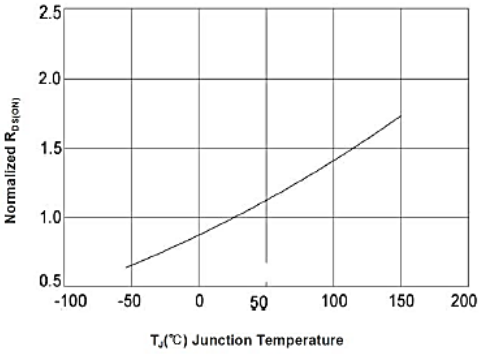


Figure 8: Normalized on Resistance vs. Junction Temperature



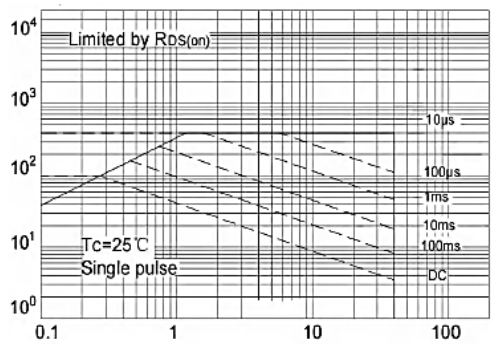


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

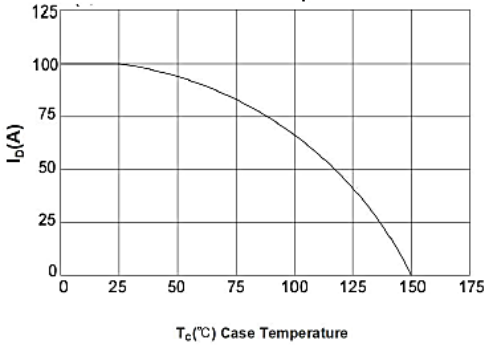


Figure 11: Normalized Maximum Transient Thermal Impedance

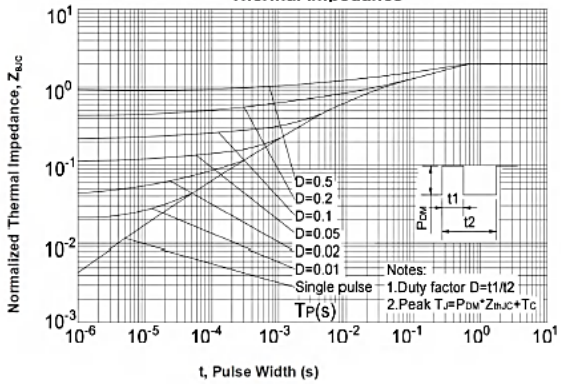
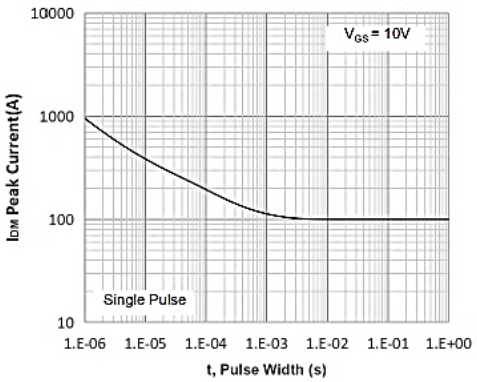


Figure 12: Peak Current Capacity



Test Circuit

Figure 1: Gate Charge Test Circuit & Waveform

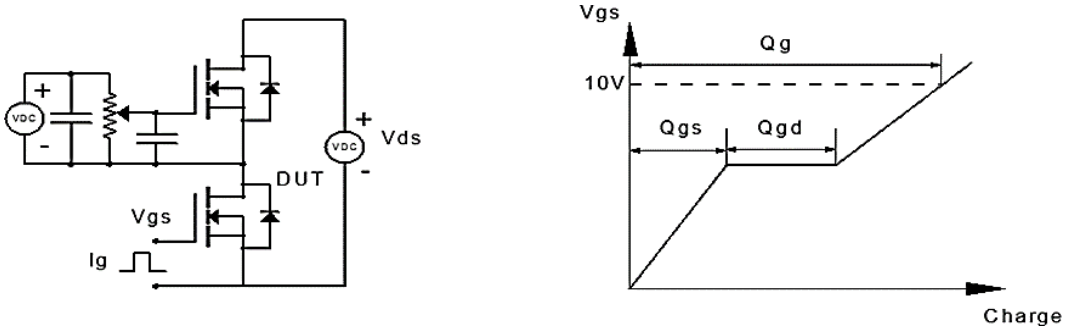


Figure 2: Resistive Switching Test Circuit & Waveform

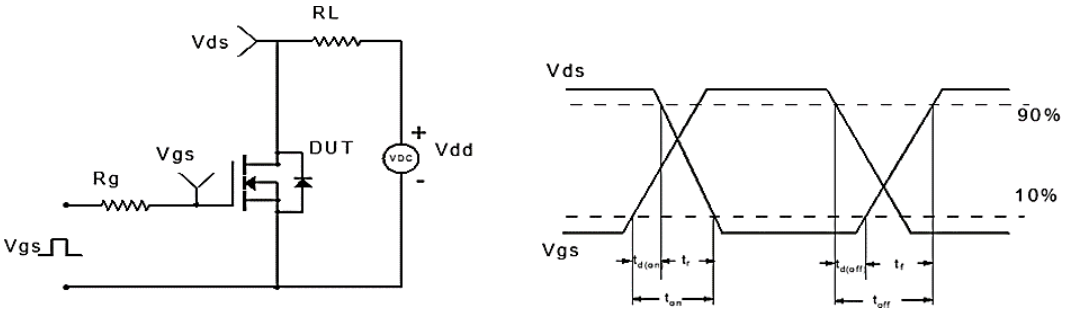


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

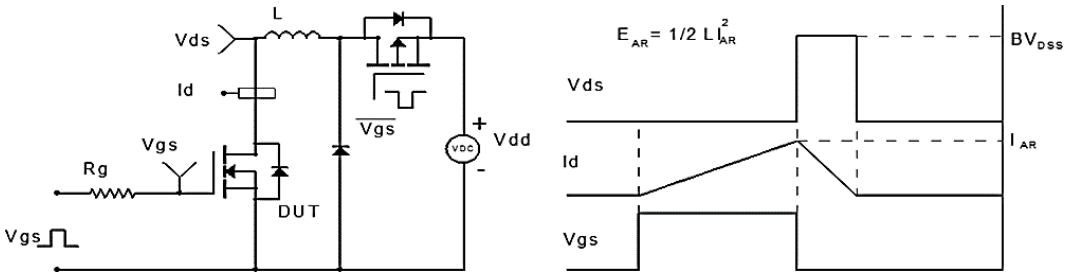
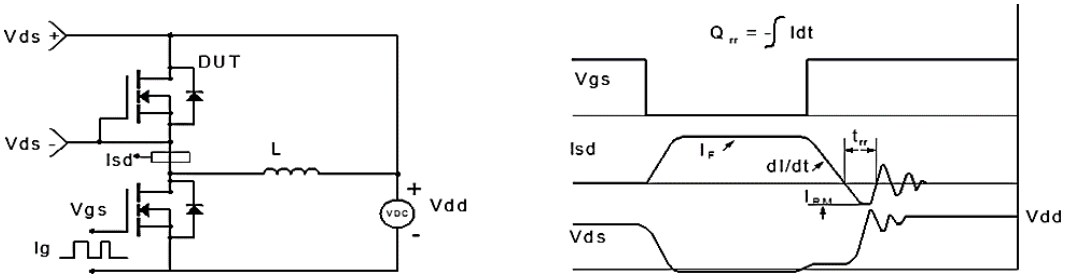
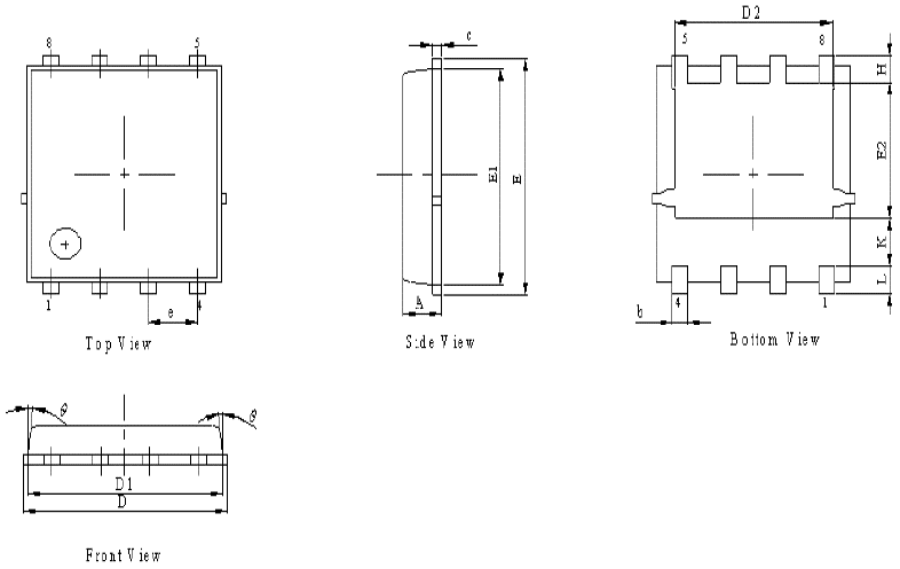


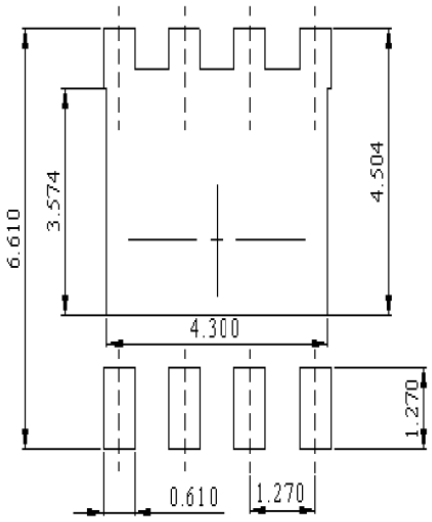
Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(PDFN 5x6-8L)



Symbol	Dimensions In Millimeters		
	Min.	NOM.	Max.
A	0.9	1	1.15
b	0.31	0.41	0.51
C	0.24	0.32	0.4
D	5	5.2	5.4
D1	4.95	5.05	5.15
D2	4	4.1	4.2
E	6.05	6.15	6.25
E1	5.5	5.6	5.7
E2	3.42	3.53	3.63
e		1.27 BSC	
H	0.6	0.7	0.8
L	0.5	0.7	0.8
K		1.23 BEF	
O			10



DIMENSIONS:MILLIMETERS

Ordering information

Order Code	Package	V_{DS}(V)	I_D(A)	$R_{DS(ON)}$(mΩ)	
QNN180N04AX	PDFN 5x6-8	40	100	V_{GS}=10V	2.2
				V_{GS}=4.5V	3